



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Applicants David G. Wang and  
P. Keith Muller

Serial No.: 10/016,624

Filed: December 10, 2001

Title: Heat Sink For Enhanced  
Heat Dissipation

§ Group Art Unit:

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Examiner:

Docket No.: 9926 (NCR.0057US)

Commissioner for Patents  
Washington, DC 20231

INFORMATION DISCLOSURE STATEMENT

Dear Sir:

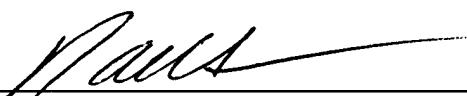
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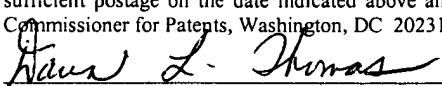
Applicant submits the references listed on the attached form PTO 1449, copies of which are enclosed. This statement is being filed before the receipt of a first Office Action on the merits. Please apply any charges and/or credits to Deposit Account No. 50-1673 (9926).

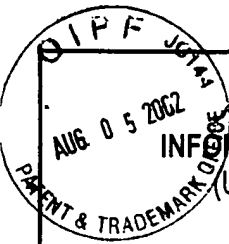
Respectfully submitted,

Date

7-26-02

  
Dan C. Hu, Reg. No. 40,025  
Trop, Pruner & Hu, P.C.  
8554 Katy Freeway, Ste. 100  
Houston, TX 77024  
713/468-8880  
713/468-8883 [fax]

Date of Deposit: July 26, 2002  
I hereby certify under 37 CFR 1.8(a) that this correspondence is being deposited with the United States Postal Service as **first class mail** with sufficient postage on the date indicated above and is addressed to the Commissioner for Patents, Washington, DC 20231.  
  
Dawn L. Thomas



**INFORMATION DISCLOSURE CITATION**

(Use several sheets if necessary)

ATTY DOCKET NO.

9926 (NCR.0057US)

SERIAL NO.

10/016,624

APPLICANT(S):

David G. Wang and P. Keith Muller

FILING DATE:

December 10, 2001

GROUP ART UNIT:

**U.S. PATENT DOCUMENTS**

*EXAMINER INITIAL		DOCUMENT NUMBER	DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	A.						
	B.						
	C.						
	D.						
	E.						
	F.						
	G.						
	H.						
	I.						
	J.						

**FOREIGN PATENT DOCUMENTS**

		DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	TRANSLATION	
							YES	NO
	K.							
	L.							
	M.							
	N.							
	O.							
	P.							

**OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, Etc.)

Q.	THERMACORE INTERNATIONAL, INC., Heat Pipe Technology, How it Works, 1 page (dated at least as early as November 15, 2001).
R.	THERMACORE INTERNATIONAL, INC., Heat Pipe Technology, Frequently Asked Questions about Heat Pipes, pp. 1-4 (dated at least as early as November 15, 2001).
S.	
T.	
U.	

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EXAMINER

DATE CONSIDERED

\*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.